June 2009



# FDI030N06 N-Channel PowerTrench<sup>®</sup> MOSFET 60V, 193A, $3.2m\Omega$

## Features

- $R_{DS(on)} = 2.6m\Omega$  (Typ.)@  $V_{GS} = 10V$ ,  $I_D = 75A$
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant



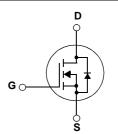
## Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

## Application

DC to DC Convertors / Synchronous Rectification





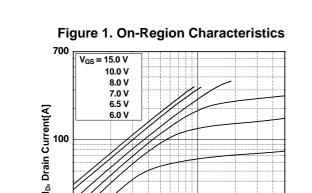
## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol		Ratings	Units			
V <sub>DSS</sub>	Drain to Source Voltage	60	V			
V <sub>GSS</sub>	Gate to Source Voltage		±20			
I <sub>D</sub>	Drain Current	-Continuous (T <sub>C</sub> = 25°C	, Silicon Limited)	193*		
		-Continuous ( $T_C = 100^{\circ}$	-Continuous (T <sub>C</sub> = 100 <sup>o</sup> C, Silicon Limited)			
		-Continuous (T <sub>C</sub> = 25°C	, Package Limited)	120		
I <sub>DM</sub>	Drain Current	- Pulsed	- Pulsed (Note 1)			
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Not			1434	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	6	V/ns	
P <sub>D</sub>	Dawar Diasis atian	$(T_{\rm C} = 25^{\rm o}{\rm C})$		231	W	
	Power Dissipation	- Derate above 25°C	1.54	W/ºC		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

## Thermal Characteristics

Symbol	Parameter	Ratings	Units	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	0.65	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	62.5	C/W	

Device Marking		Device Packag		ge Reel Size Tap		e Width		Quantity			
			TO-262		-		-		50		
Electric	al Chara	acteristics T <sub>C</sub> =	25°C unless o	otherwise n	oted						
Symbol		Parameter		-	Test Conditions	5	Min.	Тур.	Max.	Unit	
Off Chara	acteristics	S									
BV <sub>DSS</sub>	Drain to	Source Breakdown V	oltage	I <sub>D</sub> = 250μ	A, $V_{GS} = 0V, T_C$	= 25°C	60	-	-	V	
ΔBV <sub>DSS</sub>		own Voltage Temperati	Iro					0.05		V/°	
$\Delta T_{J}$	Coefficie	ent		$I_D = 1mA$ , Referenced to $25^{\circ}C$			-	0.05	-	V/*	
I <sub>DSS</sub>	Zero Ga	te Voltage Drain Curre		$V_{DS} = 48V, V_{GS} = 0V$			-	-	1	μA	
		-		$V_{DS} = 48V, T_{C} = 150^{\circ}C$			-	-	500		
I <sub>GSS</sub>	Gate to	Body Leakage Curren	t	$V_{GS} = \pm 20$	V, $V_{DS} = 0V$		-	-	±100	nA	
On Chara	cteristics	5									
V <sub>GS(th)</sub>	Gate Th	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_D = 250 \mu A$			3.5	4.5	V	
R <sub>DS(on)</sub>		rain to Source On Res	istance	$V_{GS} = 10V, I_D = 75A$			-	2.6	3.2	m۵	
9FS	Forward	Transconductance		$V_{DS} = 10V, I_D = 75A$ (Note 4)			-	154	-	S	
Dunamia	Characte	rictics	H			¥					
								7000	0045	-	
Ciss		Capacitance		V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V			-	7380	9815	pF	
C <sub>oss</sub>		Capacitance		f = 1MHz			-	1095	1455	pF	
C <sub>rss</sub>		e Transfer Capacitance					-	415 116	625 151	pF nC	
Q <sub>g(tot)</sub> Q <sub>gs</sub>		Gate Charge at 10V o Source Gate Charge o Drain "Miller" Charge		$V_{DS} = 48V, I_D = 75A$ $V_{GS} = 10V$			-	40	-	nC	
Q <sub>gd</sub>							_	35	_	nC	
≪ga	Ould to			(Note 4, 5)				00			
Switching	g Charact	teristics									
t <sub>d(on)</sub>	Turn-On	Delay Time					-	39	87	ns	
t <sub>r</sub>	Turn-On	Rise Time		$V_{DD} = 30V, I_D = 75A \\ V_{GS} = 10V, R_{GEN} = 4.7\Omega $ (Note 4, 5)			-	178	366	ns	
t <sub>d(off)</sub>	Turn-Off	Delay Time					-	54	118	ns	
t <sub>f</sub>	Turn-Off	Fall Time					-	33	76	ns	
Drain-So	urce Diod	le Characteristic	e								
		m Continuous Drain to		Forward (	urrent		_	-	193	A	
I <sub>S</sub> I <sub>SM</sub>		n Pulsed Drain to Sou					-	-	772	A	
V <sub>SD</sub>		Source Diode Forward		$V_{GS} = 0V,$			-	-	1.3	V	
t <sub>rr</sub>		Recovery Time	-	$V_{GS} = 0V,$ $V_{GS} = 0V,$			-	46	-	ns	
Q <sub>rr</sub>		Recovery Charge		$dI_F/dt = 10$	05	(Note 4)	-	50	-	nC	
Notes:	ting: Dulas with		tomporation				1		1	1	
	-	n limited by maximum junction = 50V, R <sub>G</sub> = 25Ω, Starting T <sub>J</sub> =									
		$_{DD} \leq BV_{DSS}$ , Starting T <sub>J</sub> = 25°									
4. Pulse Test: P	ulse width $\leq 300$	μs, Duty Cycle ≤ 2%									
5. Essentially In	dependent of Op	perating Temperature Typical	Characteristics								



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**Typical Performance Characteristics** 

### Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

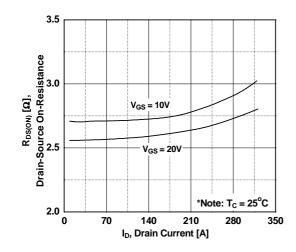
V<sub>DS</sub>, Drain-Source Voltage[V]

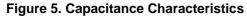
\*Notes:

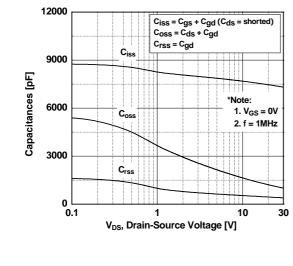
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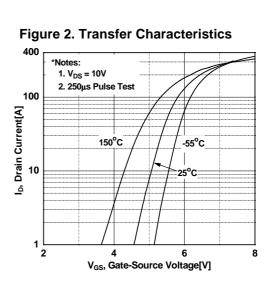
1. 250μs Pulse Test 2. T<sub>C</sub> = 25<sup>°</sup>C

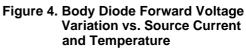
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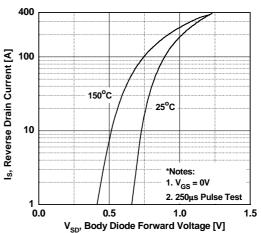




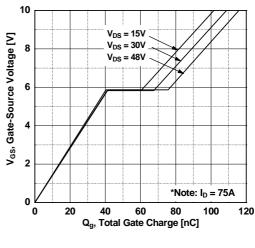




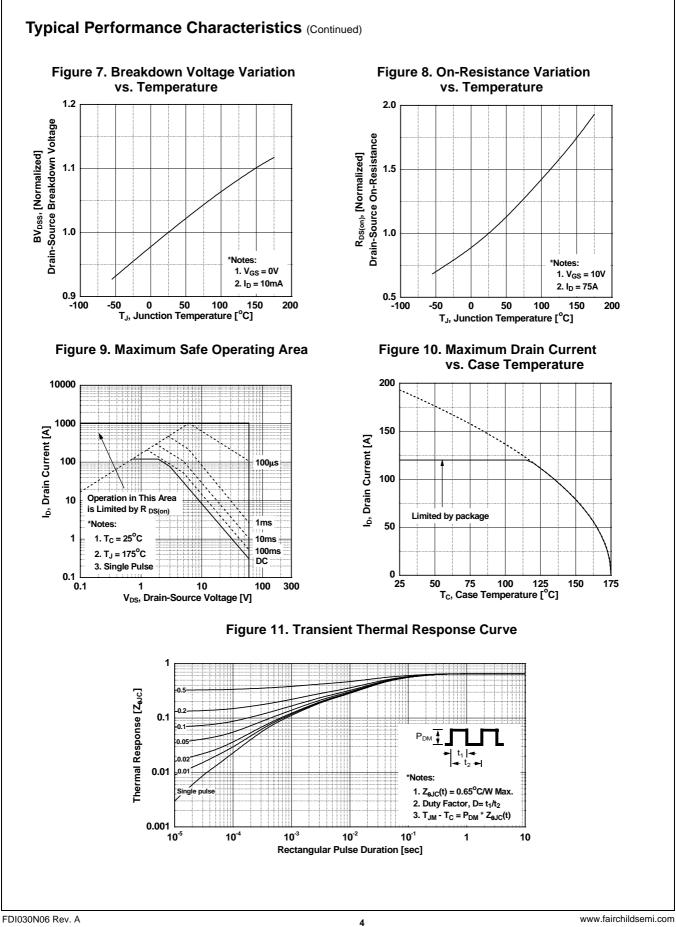




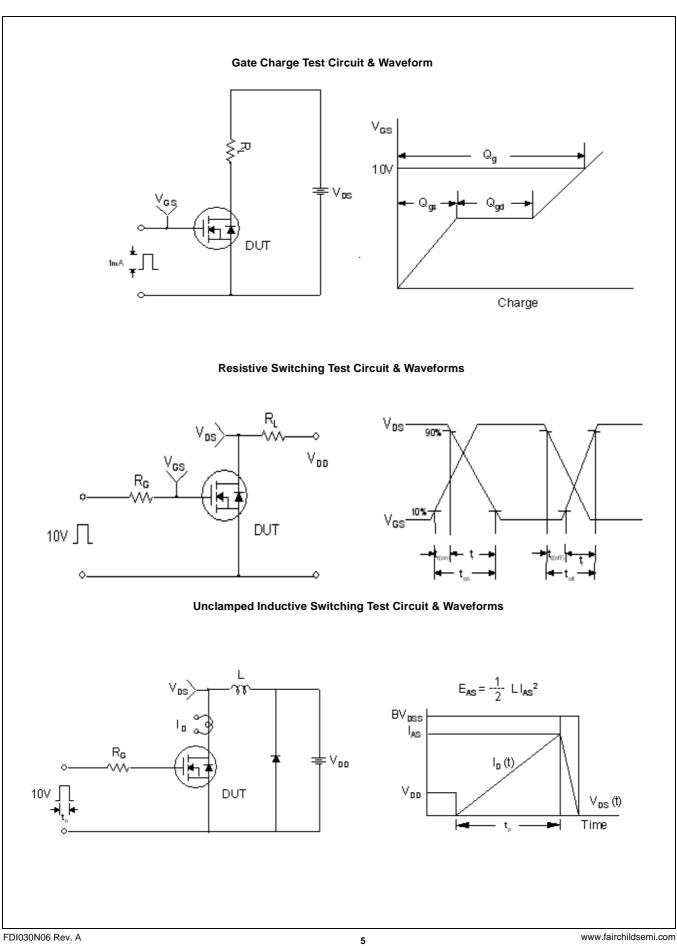




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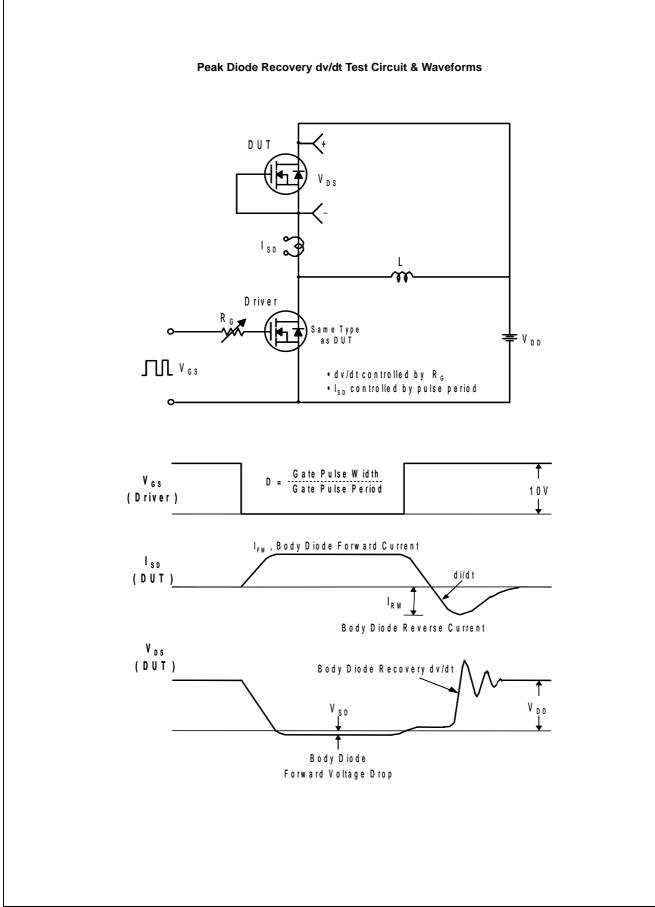


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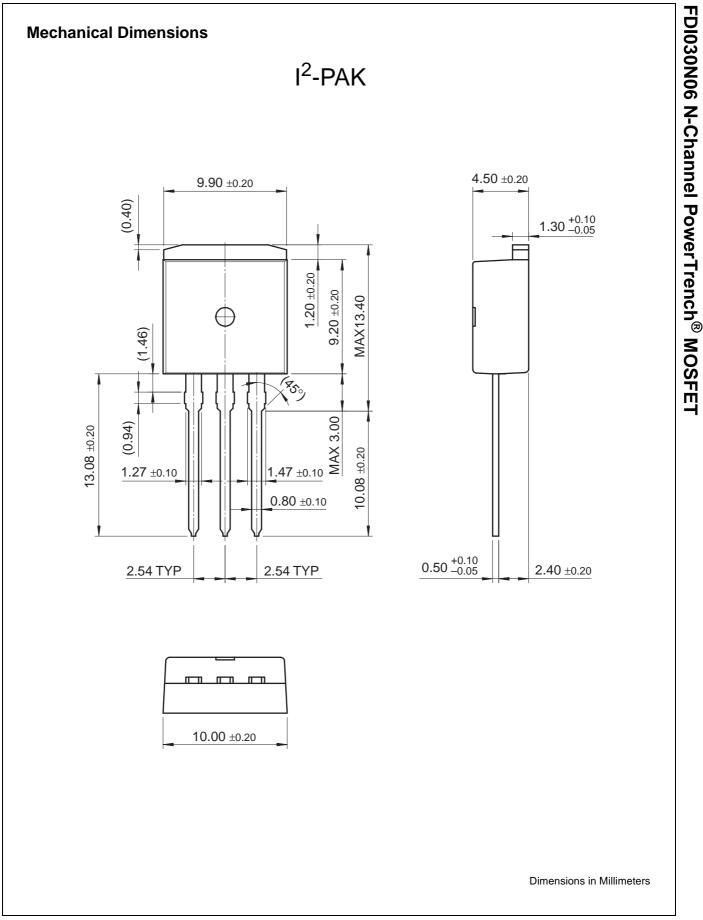


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